APT60DQ120SG

Datasheet Ultrafast Soft Recovery Rectifier Diode

Final April 2018



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Contents

1	Revision History	1
	1.1 Revision A	1
2	Des dust Quernieur	2
2	Product Overview	Z
	2.1 Benefits	2
	2.2 Applications	2
3	Electrical Specifications	3
	3.1 Absolute Maximum Ratings	3
	3.2 Electrical Performance	3
	3.3 Dynamic Characteristics	4
	3.4 Typical Performance Curves	4
	3.5 Reverse Recovery Overview	6
4	Package Specification	7
	4.1 Package Outline Drawing	7



1 Revision History

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

1.1 Revision A

Revision A was published in April 2018. It is the first publication of this document.



2

Product Overview



Features

The following are key features of the APT60DQ120SG device:

- Ultrafast recovery times
- Soft recovery characteristics
- Low forward voltage
- Low leakage current
- Avalanche energy rated
- RoHS compliant

2.1 Benefits

The following are benefits of the APT60DQ120SG device:

- Higher switching frequency
- Low switching losses
- Low noise (EMI) switching
- Higher reliability systems
- Increased system power density

2.2 Applications

The APT60DQ120SG device is designed for the following applications:

- Power Factor Correction (PFC)
- Anti-parallel diode
 - Switch-mode power supply
 - Inverters/converters
 - Motor controllers
- Freewheeling diode
 - Switch-mode power supply
 - Inverters/converters
- Snubber/clamp diode



3 Electrical Specifications

This section shows the electrical specifications for the APT60DQ120SG device.

3.1 Absolute Maximum Ratings

The following table shows the absolute maximum ratings for the APT60DQ120SG device.

All ratings: Tc = 25 °C unless otherwise specified.

Table 1 • Absolute Maximum Ratings

Symbol	Parameter	Ratings	Unit
VR	Maximum DC reverse voltage		V
VRRM	Maximum peak repetitive reverse voltage	1200	
VRWM	Maximum working peak reverse voltage	1200	
F(AV)	Maximum average forward current (Tc = 103 °C, duty cycle = 0.5)	60	А
F(RMS)	RMS forward current	87	
IFSM	Non-repetitive forward surge current (T ₁ = 45 °C, 8.3 ms)	540	
Eavl	Avalanche energy (1 A, 40 mH)	20	mJ
TJ , TSTG	Operating and storage temperature range	–55 to 175	°C
Τι	Lead temperature for 10 seconds	300	

The following table shows the thermal and mechanical characteristics of the APT60DQ120SG device.

Table 2 • Thermal and Mechanical Characteristics

Symbol	Characteristic	Min	Тур	Max	Unit
Reic	Junction-to-case thermal resistance			0.40	°C/W
WT	Package weight		0.14		OZ
			4.0		g

3.2 Electrical Performance

The following table shows the static characteristics of the APT60DQ120SG device.

Table 3 • Static Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
VF	Forward Voltage	I _F = 60 A		2.8	3.3	V
		IF = 120 A		3.35		_
		IF = 60 A, TJ = 125 °C		2.11		_
Irm	Maximum reverse leakage current	V _R = 1200 V			100	μΑ
		V _R = 1200 V, T _J = 125 °C			500	_
C	Junction capacitance	V _R = 200 V		37		pF



3.3 Dynamic Characteristics

The following table shows the dynamic characteristics of the APT60DQ120SG device.

Table 4 • Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
trr	Reverse recovery time	I _F = 1 A, dir/dt = -100 A/μs V _R = 30 V T _J = 25 °C		30		ns
trr	Reverse recovery time	I _F = 60 A, di _F /dt = -200 A/μs		320		_
Qrr	Reverse recovery change	 V_R = 800 V T_c = 25 °C 		630		nC
Irrm	Maximum reverse recovery current			5		A
trr	Reverse recovery time	I _F = 60 A, di _F /dt = -200 A/μs		420		ns
Qrr	Reverse recovery charge	$V_{R} = 800 V$ T _C = 125 °C		2810		nC
Irrm	Maximum reverse recovery current	12-125 C		12		A
trr	Reverse recovery time	IF = 60 A, diF/dt = -1000 A/µs		190		ns
Qrr	Reverse recovery change	 V_R = 800 V T_c = 125 °C 		4415		nC
IRRM	Maximum reverse recovery current			38		A

3.4 Typical Performance Curves

This section shows the typical performance curves for the APT60DQ120SG device.



Figure 1 • Maximum Transient Thermal Impedance



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Figure 4 • Qrr vs. Current Rate of Change







Figure 3 • trr vs. Current Rate of Change



Figure 5 • IRRM vs. Current Rate of Change



Figure 7 • Maximum Average Forward Current vs. Case Temperature





Figure 8 • Junction Capacitance vs. Reverse Voltage



3.5 Reverse Recovery Overview

The following illustration shows the reverse recovery testing and measurement information for the APT60DQ120SG device.

Figure 9 • Diode Reverse Recovery Waveform and Definitions



- 1. IF—Forward conduction current.
- 2. dir/dt-Rate of diode current change through zero crossing.
- 3. IRRM—Maximum reverse recovery current.
- 4. trr—Reverse recovery time, measured from zero crossing where diode current goes from positive to negative, to the point at which the straight line through IRRM and 0.25 × IRRM passes through zero.
- 5. Qrr—Area under the curve defined by I_{RRM} and $t_{\text{rr}}.$



4 Package Specification

This section outlines the package specification for the APT60DQ120SG device.

4.1 Package Outline Drawing

This section details the D³PAK package drawing of the APT60DQ120SG device. Dimensions are in millimeters and (inches).

Figure 10 • Package Outline Drawing







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Microsemi Corporate Headquarters One Enterprise, Aliso Viejo, CA 92656 USA Within the USA: +1 (800) 713-4113 Outside the USA: +1 (949) 380-6100 Fax: +1 (949) 215-4996 Email: sales.support@microsemi.com

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